PNE20010ER

200 V, 1 A hyperfast recovery rectifier

3 January 2019 **Product data sheet**

1. General description

High power density, hyperfast recovery rectifier with high-efficiency planar technology, encapsulated in a small and flat lead SOD123W Surface-Mounted Device (SMD) plastic package.

2. Features and benefits

- Reverse voltage $V_R \leq 200$ V
- Forward current $I_F \leq 1$ A
- Hyperfast recovery time $t_{rr} \leq 25$ ns
- Pt doped lifetime control
- Low inductance
- Small and flat lead SMD plastic package
- Package height typ. 1 mm
- High power capability due to clip-bond technology
- Planar die design
- Capable for reflow and wave soldering
- AEC-Q101 qualified

3. Applications

- General-purpose rectification
- Reverse polarity protection
- Hyperfast switching
- Freewheeling applications

4. Quick reference data

Table 1. Quick reference data

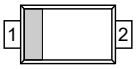
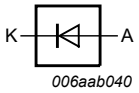
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$I_{F(AV)}$	average forward current	δ = 0.5; f = 20 kHz; square wave; $T_{sp} \leq$ 165 °C		-	-	1	A
V_{RRM}	repetitive peak reverse voltage	T_j = 25 °C		-	-	200	V
V_R	reverse voltage			-	-	200	V
V_F	forward voltage	I_F = 1 A; pulsed; T_j = 25 °C	[1]	-	845	930	mV
		I_F = 1 A; pulsed; T_j = 125 °C	[1]	-	700	790	mV
I_R	reverse current	V_R = 200 V; pulsed; T_j = 25 °C	[1]	-	10	200	nA
		V_R = 200 V; pulsed; T_j = 125 °C	[1]	-	1.5	20	µA

[1] Very short pulse, in order to maintain a stable junction temperature.

nexperia

5. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	 CFP3 (SOD123W)	
2	A	anode		

6. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PNE20010ER	CFP3	plastic, surface mounted package; 2.6 mm x 1.7 mm x 1 mm body	SOD123W

7. Marking

Table 4. Marking codes

Type number	Marking code
PNE20010ER	K3

8. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{RRM}	repetitive peak reverse voltage	T_j = 25 °C		-	200	V
V_R	reverse voltage			-	200	V
V_{RMS}	RMS voltage			-	140	V
I_F	forward current	δ = 1; $T_{sp} \leq$ 162 °C		-	1.4	A
$I_{F(AV)}$	average forward current	δ = 0.5; f = 20 kHz; square wave; $T_{sp} \leq$ 165 °C		-	1	A
I_{FSM}	non-repetitive peak forward current	t_p = 8.3 ms; $T_{j(init)}$ = 25 °C; single half sine wave (applied at reated load condition)		-	38	A
P_{tot}	total power dissipation	$T_{amb} \leq$ 25 °C	[1]	-	882	mW
			[2]	-	1.43	W
T_j	junction temperature			-	175	°C
T_{amb}	ambient temperature			-55	175	°C
T_{stg}	storage temperature			-65	175	°C

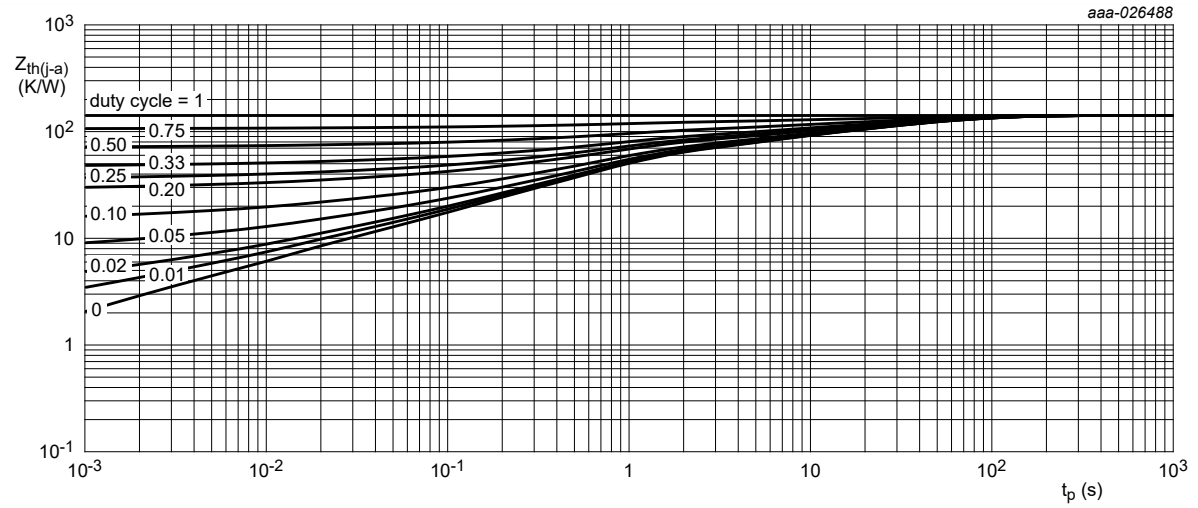
[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm^2.

9. Thermal characteristics

Table 6. Thermal characteristics

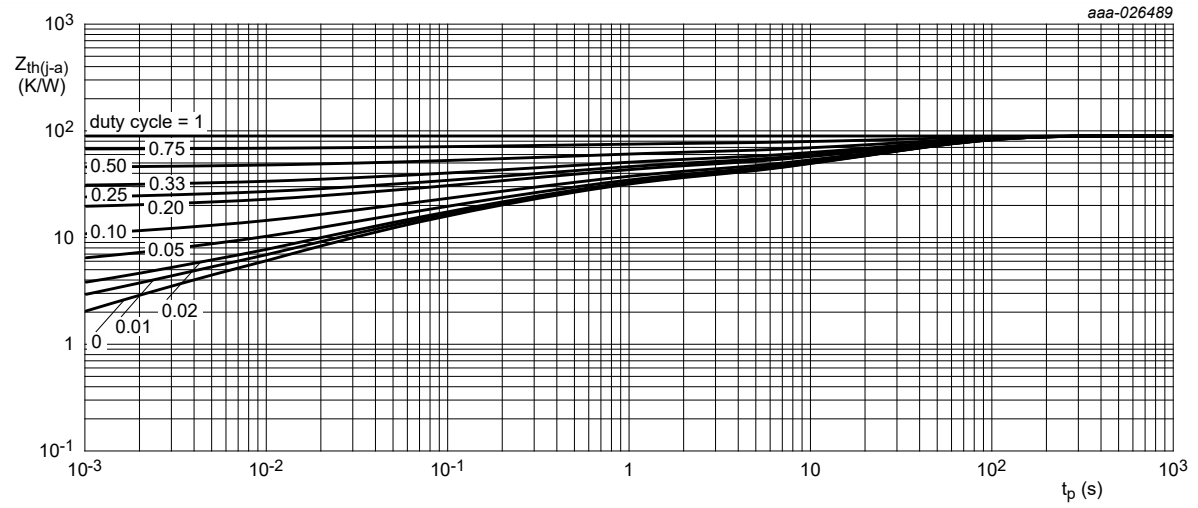
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1]	-	-	170	K/W
			[2]	-	-	105	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[3]	-	-	15	K/W

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm^2.
[3] Soldering point of cathode tab.



FR4 PCB, standard footprint

Fig. 1. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for cathode 1 cm^2

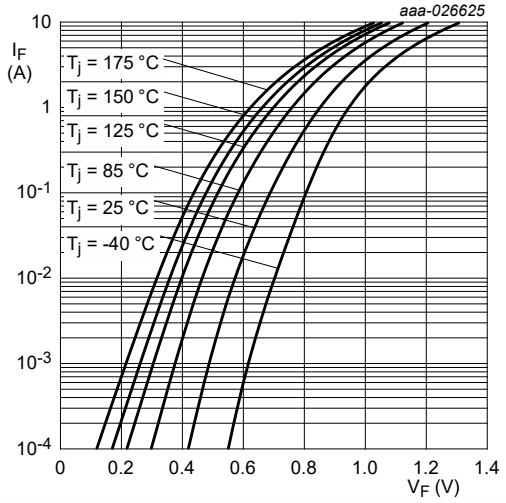
Fig. 2. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

10. Characteristics

Table 7. Characteristics

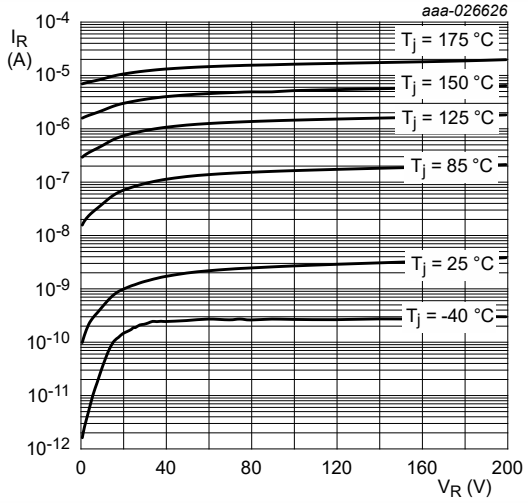
Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	I_R = 100 µA; pulsed; T_j = 25 °C	[1]	200	-	-	V
V_F	forward voltage	I_F = 1 A; pulsed; T_j = 25 °C	[1]	-	845	930	mV
		I_F = 1 A; pulsed; T_j = 125 °C	[1]	-	700	790	mV
I_R	reverse current	V_R = 200 V; pulsed; T_j = 25 °C	[1]	-	10	200	nA
		V_R = 200 V; pulsed; T_j = 125 °C	[1]	-	1.5	20	µA
C_d	diode capacitance	V_R = 4 V; f = 1 MHz; T_j = 25 °C		-	17	-	pF
t_{rr}	reverse recovery time ; step recovery	I_F = 0.5 A; I_R = 1 A; $I_{R(meas)}$ = 0.25 A; T_j = 25 °C		-	10	25	ns
	reverse recovery time ; ramp recovery	I_F = 1 A; dI_F/dt = 50 A/µs; V_R = 30 V; T_j = 25 °C		-	20	-	ns
		I_F = 1 A; dI_F/dt = 100 A/µs; V_R = 30 V; T_j = 25 °C		-	16	-	ns
I_{RM}	peak reverse recovery current			-	1.1	-	A
Q_{rr}	reverse recovery charge			-	9	-	nC
V_{FRM}	peak forward recovery voltage	I_F = 1 A; dI_F/dt = 50 A/µs; T_j = 25 °C		-	930	-	mV

[1] Very short pulse, in order to maintain a stable junction temperature.



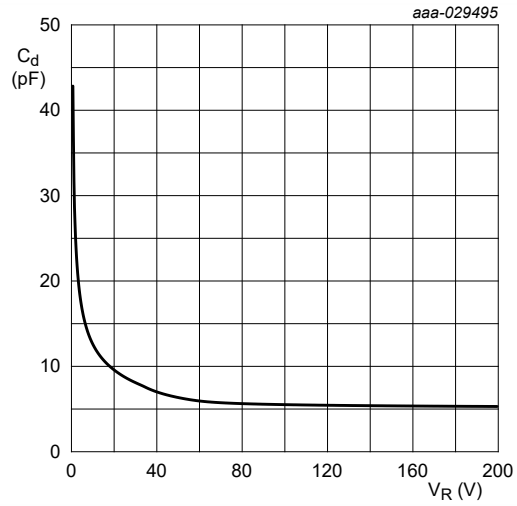
pulsed condition

Fig. 3. Forward current as a function of forward voltage; typical values



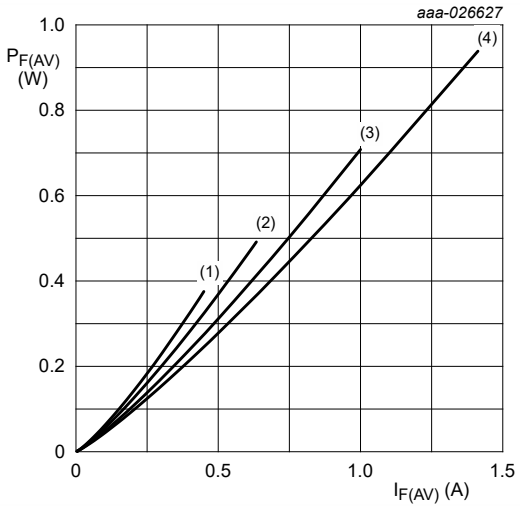
pulsed condition

Fig. 4. Reverse current as a function of reverse voltage; typical values



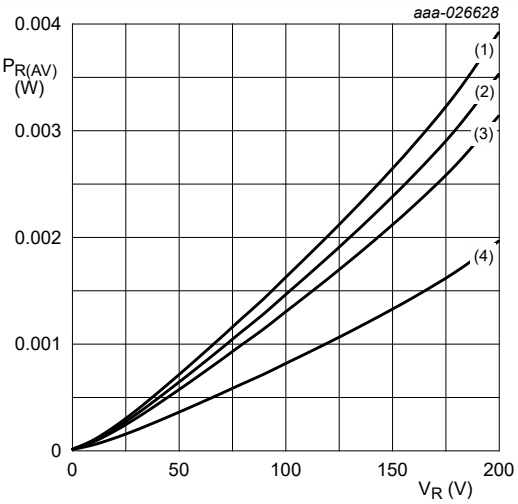
f = 1 MHz; T_{amb} = 25 °C

Fig. 5. Diode capacitance as a function of reverse voltage; typical values



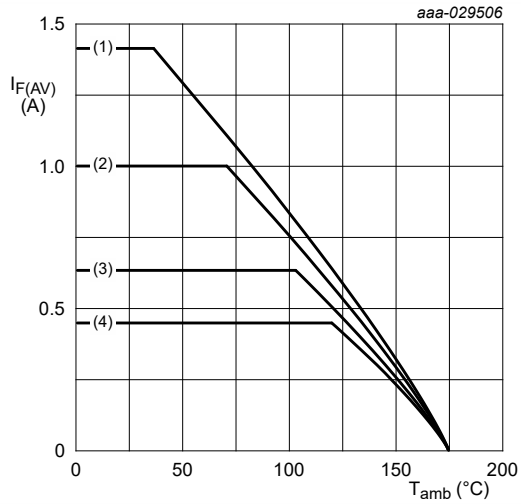
T_j = 175 °C
(1) δ = 0.1
(2) δ = 0.2
(3) δ = 0.5
(4) δ = 1; DC

Fig. 6. Average forward power dissipation as a function of average forward current; typical values



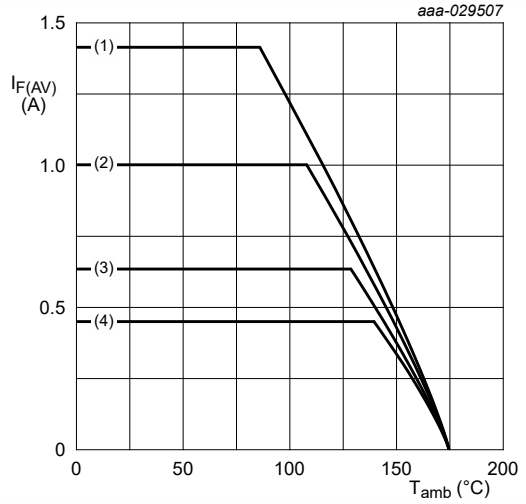
T_j = 175 °C
(1) δ = 1; DC
(2) δ = 0.9
(3) δ = 0.8
(4) δ = 0.5

Fig. 7. Average reverse power dissipation as a function of reverse voltage; typical values



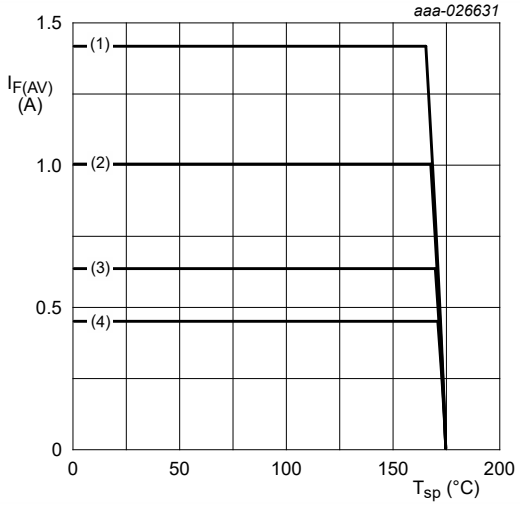
FR4 PCB, standard footprint
T_j = 175 °C
(1) δ = 1; DC
(2) δ = 0.5; f = 20 kHz
(3) δ = 0.2; f = 20 kHz
(4) δ = 0.1; f = 20 kHz

Fig. 8. Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode 1 cm ^{2}
T_j = 175 °C
(1) δ = 1; DC
(2) δ = 0.5; f = 20 kHz
(3) δ = 0.2; f = 20 kHz
(4) δ = 0.1; f = 20 kHz

Fig. 9. Average forward current as a function of ambient temperature; typical values



T_j = 175 °C
(1) δ = 1; DC
(2) δ = 0.5; f = 20 kHz
(3) δ = 0.2; f = 20 kHz
(4) δ = 0.1; f = 20 kHz

Fig. 10. Average forward current as a function of solder point temperature; typical values

11. Test information

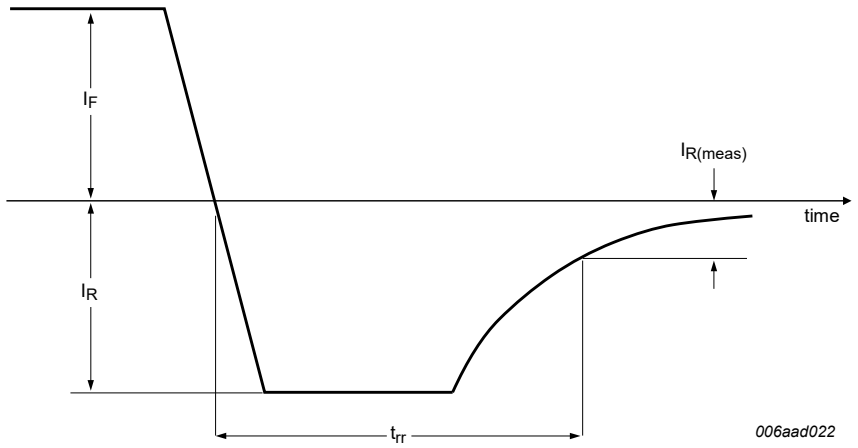


Fig. 11. Reverse recovery definition; step recovery

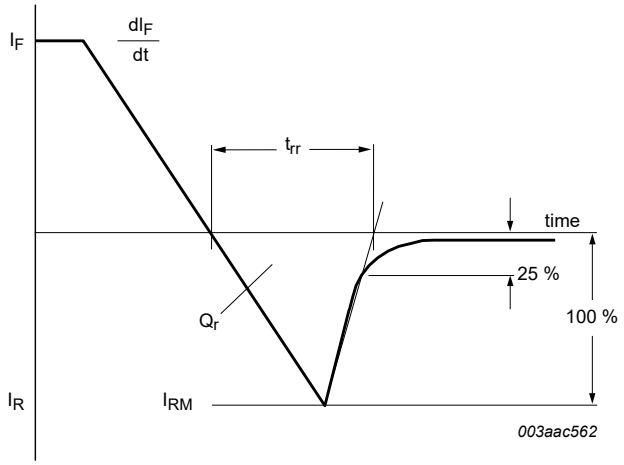


Fig. 12. Reverse recovery definition; ramp recovery

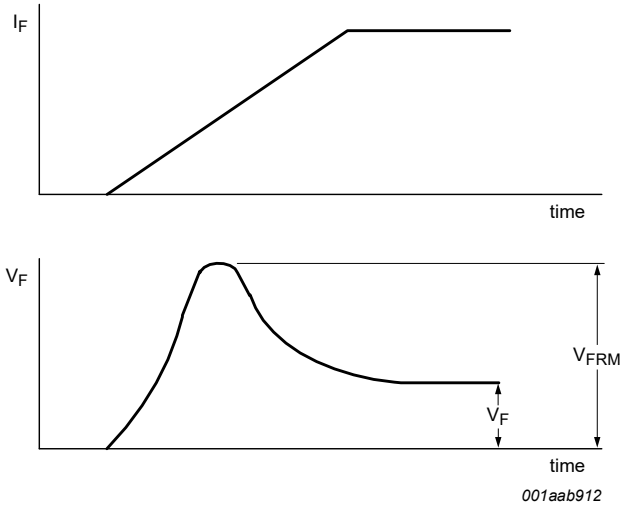


Fig. 13. Forward recovery definition

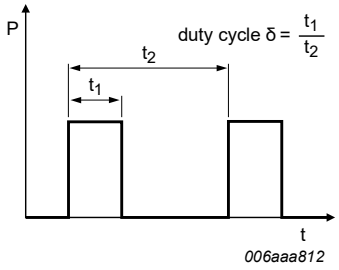


Fig. 14. Duty cycle definition

The current ratings for the typical waveforms are calculated according to the equations:

$I_{F(AV)}=I_M \times \delta$ with I_M defined as peak current

$I_{RMS}=I_{F(AV)}$ at DC, and $I_{RMS}=I_M \times \sqrt{\delta}$

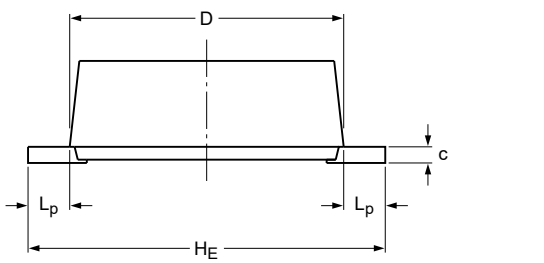
with I_{RMS} defined as RMS current.

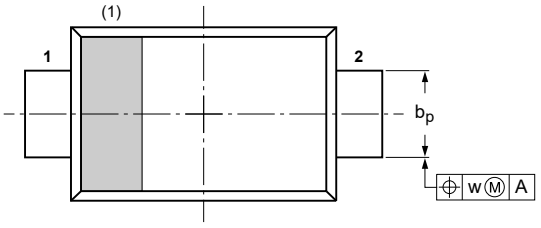
Quality information

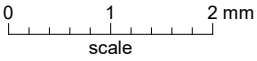
This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

12. Package outline

Plastic surface-mounted package; 2 leads **SOD123W**







DIMENSIONS (mm are the original dimensions)

UNIT	A	b_p	c	D	E	H_E	L_p	w
mm	1.1 0.9	1.05 0.75	0.22 0.10	2.8 2.4	1.9 1.5	3.7 3.3	0.6 0.3	0.13

Note

1. The marking bar indicates the cathode.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOD123W						~~07-06-28~~ 08-11-06

Fig. 15. Package outline CFP3 (SOD123W)

13. Soldering

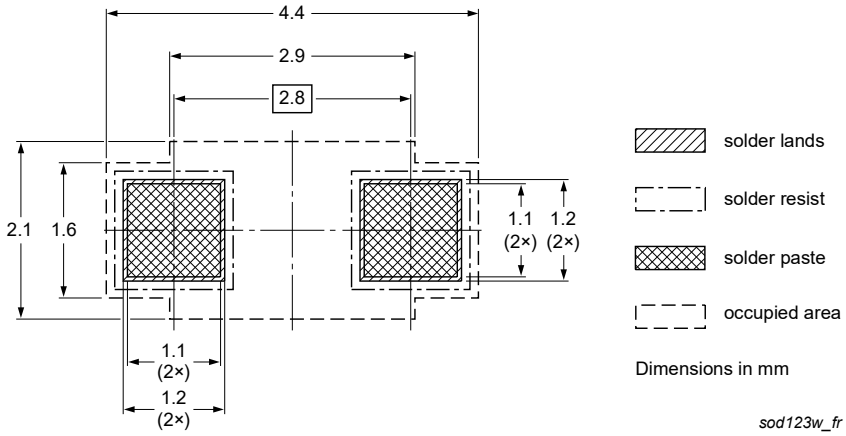
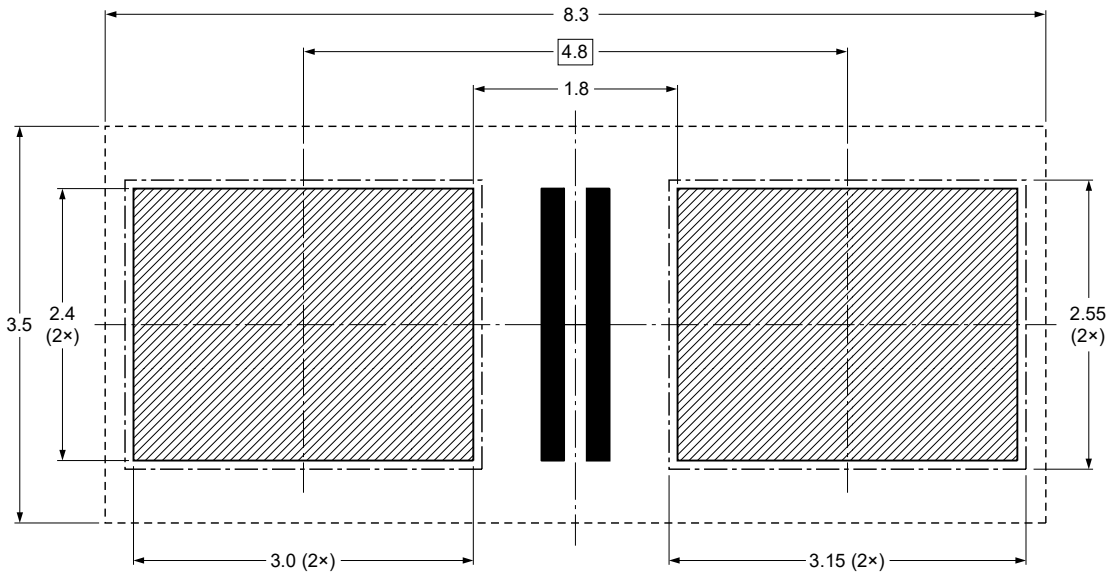


Fig. 16. Reflow soldering footprint for CFP3 (SOD123W)

Wave soldering footprint information **SOD123W**



occupied area

solder resist

solder lands

dummy track (solder resist and Cu free)

Dimensions in mm

Issue date ~~17-06-06~~ 17-06-07

sod123w_fw

Fig. 17. Wave soldering footprint for CFP3 (SOD123W)

14. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
PNE20010ER v.3	20190103	Product data sheet	-	PNE20010ER v.2
Modifications:	• Category changed from PN-rectifier to recovery rectifier • Update due to change of wafer fabrication			
PNE20010ER v.2	20170830	Product data sheet	-	PNE20010ER v.1
PNE20010ER v.1	20170519	Preliminary data sheet	-	-

15. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
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Contents

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For sales office addresses, please send an email to: salesaddresses@nexperia.com
Date of release: 3 January 2019

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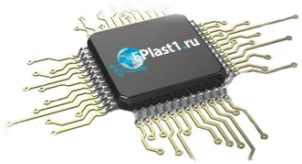
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



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Телефон: 8 (812) 309 58 32 (многоканальный)
Факс: 8 (812) 320-02-42
Электронная почта: org@eplast1.ru
Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.